

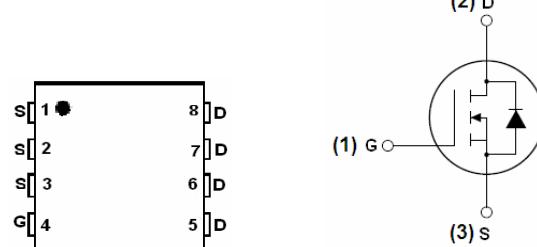
FNK N-Channel Enhancement Mode Power MOSFET

Description

The FNK10N02 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $V_{DS} = 20V, I_D = 180A$
- $R_{DS(ON)} < 2.25m\Omega @ V_{GS}=4.5V$ (Typ2.07m Ω)



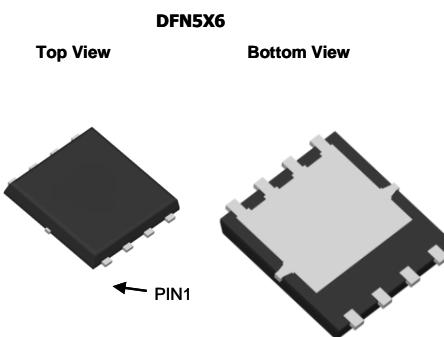
Marking and pin assignment

Schematic diagram

- High density cell design for ultra low $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Load switching
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
FNK10N02	FNK10N02	DFN5*6-8L	-	-	-

Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	V
Drain Current-Continuous	I_D	100	A
Drain Current-Continuous($T_C=100^\circ C$)	$I_D (100^\circ C)$	132	A
Pulsed Drain Current	I_{DM}	540	A
Maximum Power Dissipation	P_D	83	W
Single pulse avalanche energy ^(Note 5)	E_{AS}	504	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C

Thermal Characteristic

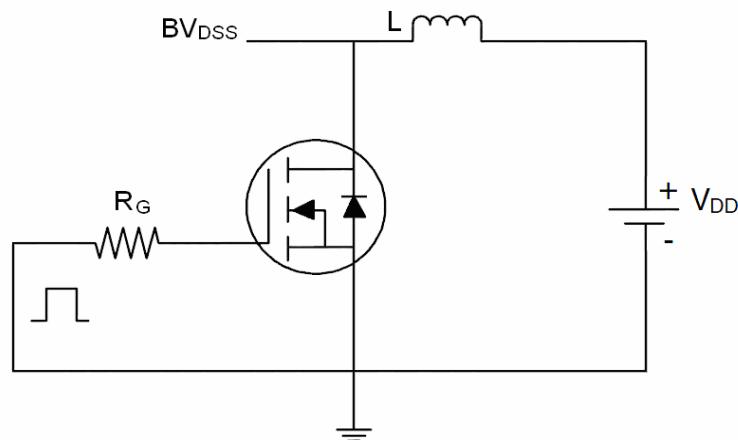
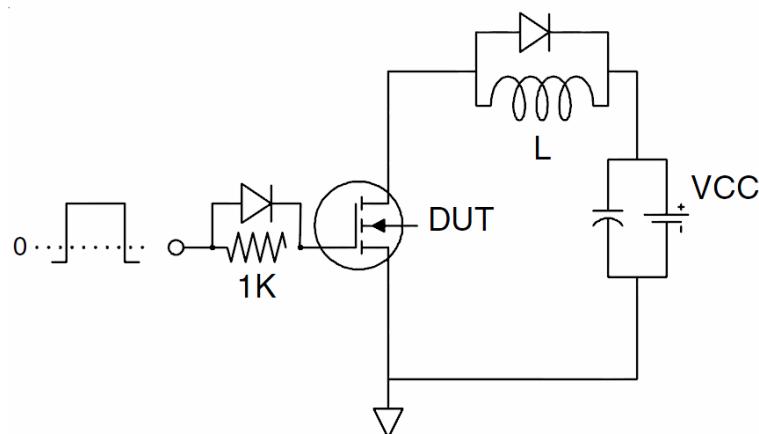
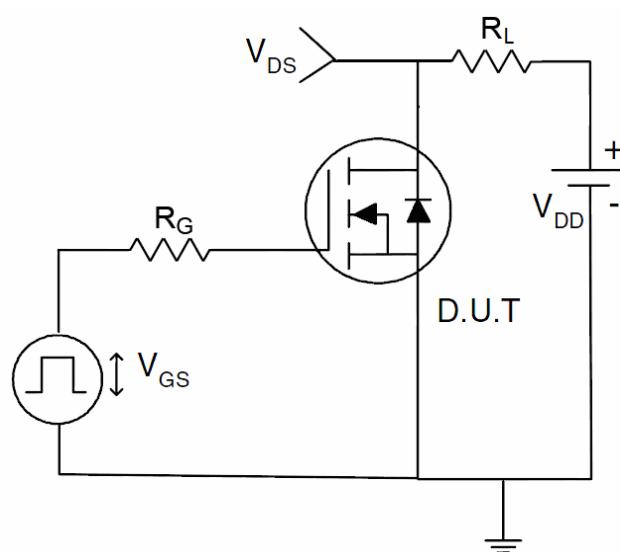
Thermal Resistance, Junction-to-Case ^(Note 2)	R_{eJC}	1.5	°C/W
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Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{D}}=250\mu\text{A}$	20	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$\text{V}_{\text{DS}}=20\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$\text{V}_{\text{GS}}=\pm 12\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	± 100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_{\text{D}}=250\mu\text{A}$	0.4	0.6	1	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_{\text{D}}=20\text{A}$	-	2.07	2.25	$\text{m}\Omega$
Drain-Source On-State Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=2.5\text{V}, \text{I}_{\text{D}}=20\text{A}$	-	2.38	2.6	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_{\text{D}}=30\text{A}$	100	-	-	S
Dynamic Characteristics (Note 4)						
Input Capacitance	C_{iss}	$\text{V}_{\text{DS}}=10\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{F}=1.0\text{MHz}$		9585		PF
Output Capacitance	C_{oss}			1145		PF
Reverse Transfer Capacitance	C_{rss}			940		PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	$t_{\text{d(on)}}$	$\text{V}_{\text{GS}}=10\text{V}, \text{V}_{\text{DS}}=10\text{V}$ $\text{RL}=0.5\Omega, \text{RGEN}=3\Omega$	-	12.5	-	nS
Turn-on Rise Time	t_r		-	35.5	-	nS
Turn-Off Delay Time	$t_{\text{d(off)}}$		-	40	-	nS
Turn-Off Fall Time	t_f		-	32.5	-	nS
Total Gate Charge	Q_g	$\text{V}_{\text{GS}}=4.5\text{V}, \text{V}_{\text{DS}}=10\text{V}, \text{I}_{\text{D}}=30\text{A}$		30.4		nC
Gate-Source Charge	Q_{gs}			9.5		nC
Gate-Drain Charge	Q_{gd}			19.8		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{S}}=20\text{A}$	-	-	1.2	V
Diode Forward Current (Note 2)	I_{S}	-	-	-	110	A
Reverse Recovery Time	t_{rr}	$\text{TJ} = 25^\circ\text{C}, \text{IF} = 30\text{A}$ $\text{di/dt} = 100\text{A}/\mu\text{s}$ (Note 3)	-	35.3	-	nS
Reverse Recovery Charge	Q_{rr}		-	30.7	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. EAS condition: $\text{Tj}=25^\circ\text{C}, \text{V}_{\text{DD}}=10\text{V}, \text{V}_{\text{G}}=10\text{V}, \text{L}=0.5\text{mH}, \text{Rg}=25\Omega$

Test circuit
1) E_{AS} test Circuits

2) Gate charge test Circuit:

3) Switch Time Test Circuit:


Typical Electrical and Thermal Characteristics (Curves)

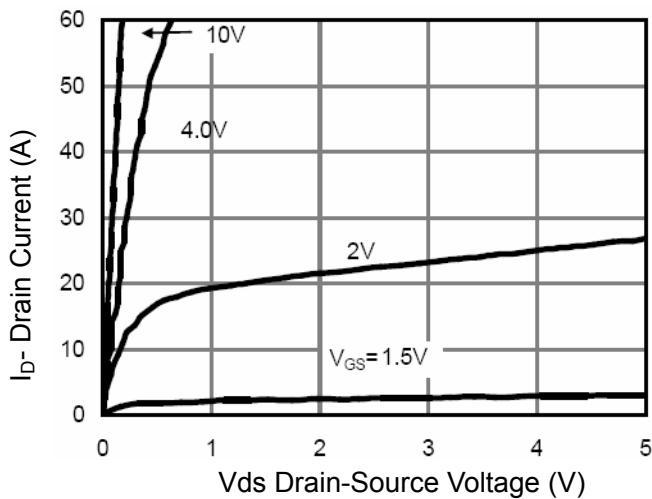


Figure 1 Output Characteristics

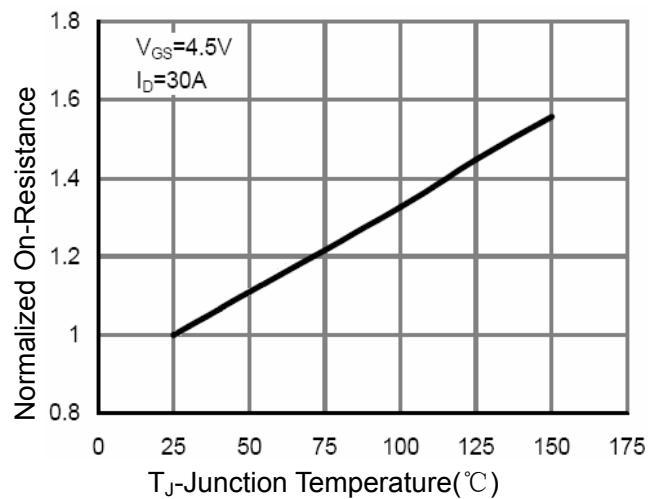


Figure 4 Rdson-Junction Temperature

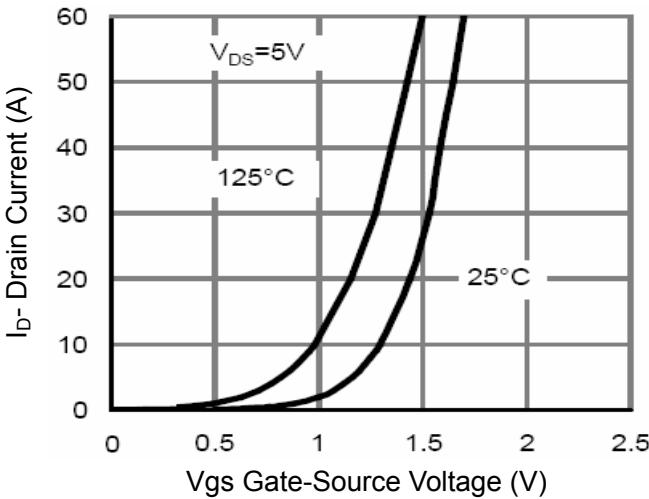


Figure 2 Transfer Characteristics

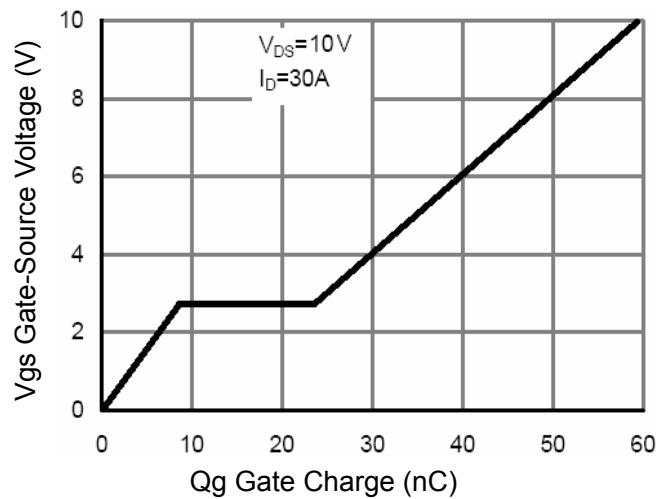


Figure 5 Gate Charge

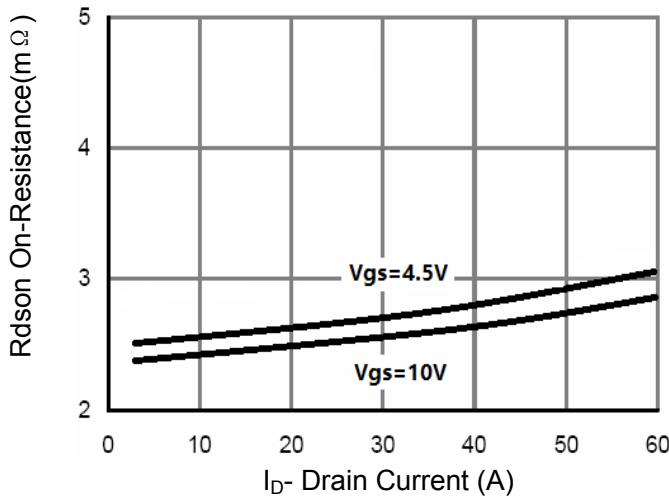


Figure 3 Rdson- Drain Current

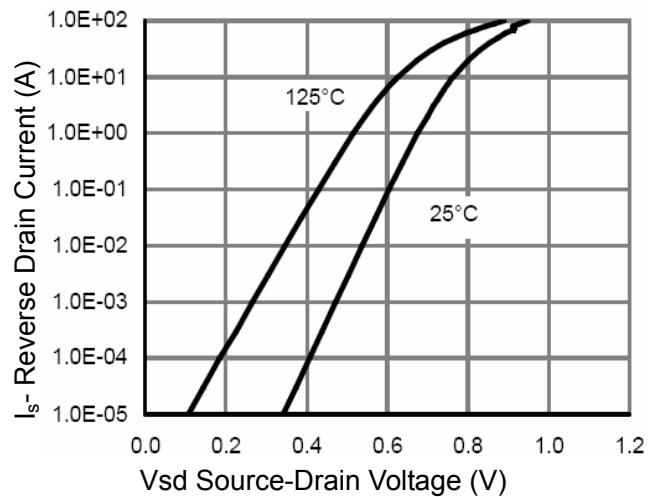
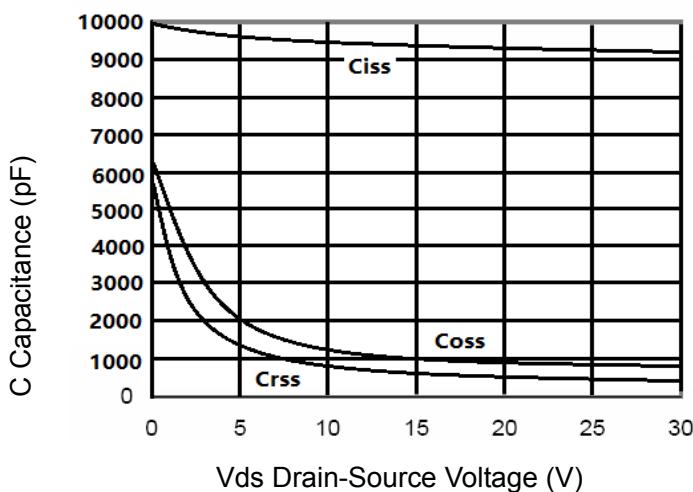
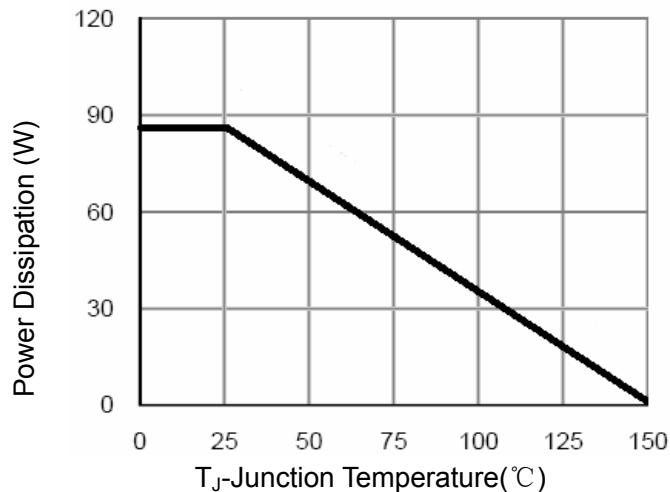
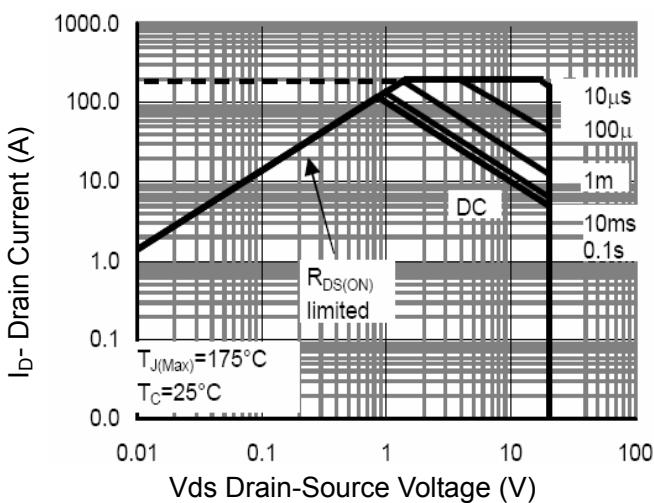
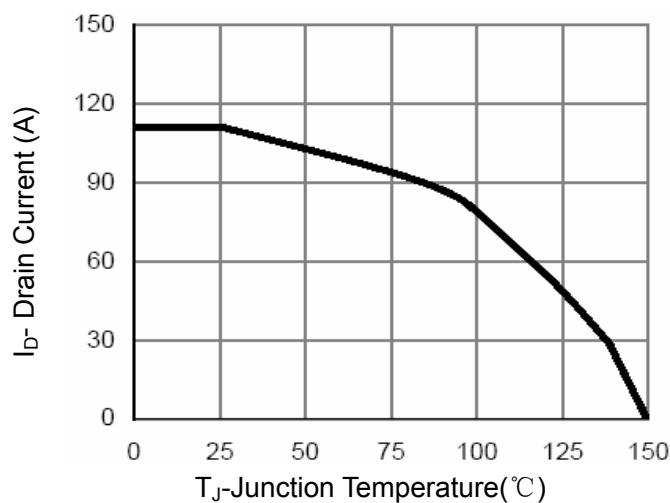
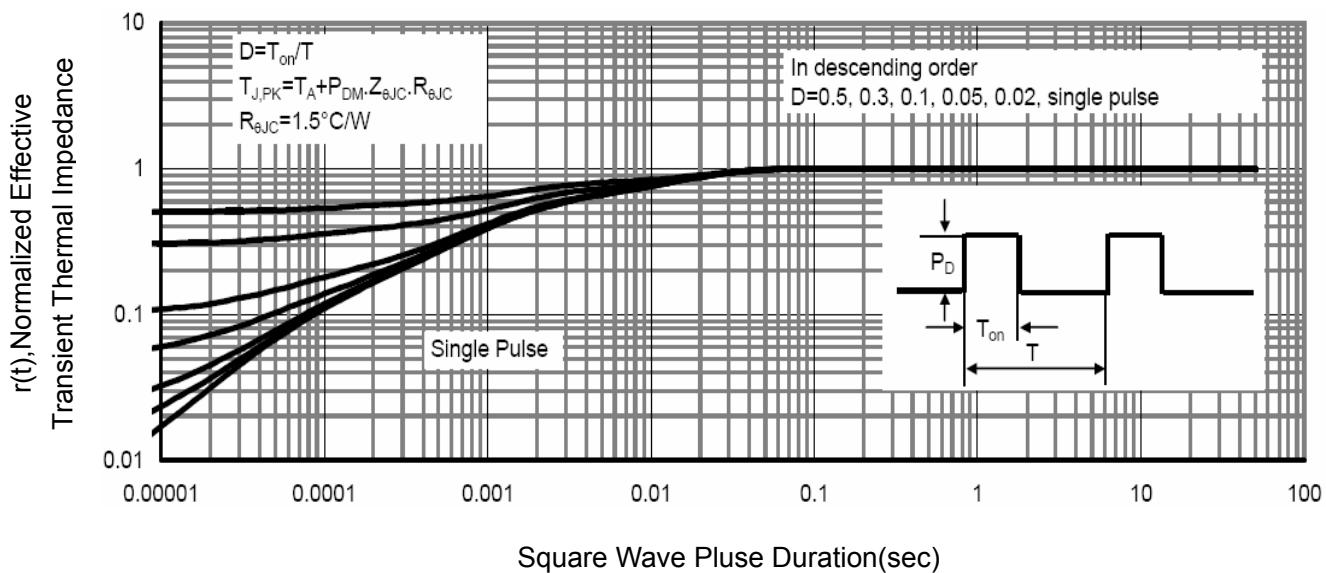
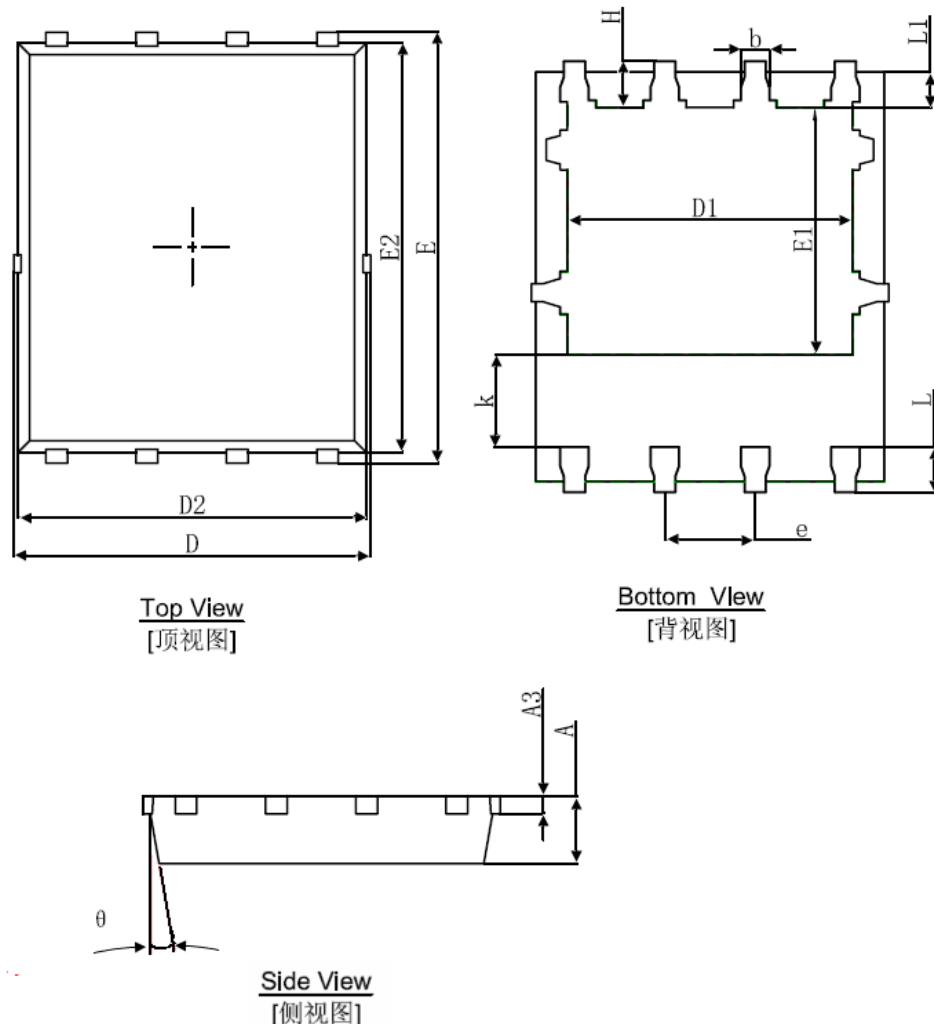


Figure 6 Source- Drain Diode Forward


Figure 7 Capacitance vs Vds

Figure 9 Power De-rating

Figure 8 Safe Operation Area

Figure 10 Current De-rating

Figure 11 Normalized Maximum Transient Thermal Impedance

DFN5X6-8L Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
K	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	8°	12°	8°	12°

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